onsemi

MOSFET – Single, N-Channel, Logic Level, POWERTRENCH[®]

30 V, 6.3 A, 25 m Ω

FDC655BN

General Description

This N-Channel Logic Level MOSFET is produced using **onsemi**'s advanced POWERTRENCH process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- Max $R_{DS(ON)} = 25 \text{ m}\Omega @ V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$
- Max $R_{DS(ON)} = 33 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}, I_D = 5.5 \text{ A}$
- Fast Switching
- Low Gate Charge
- High Performance Trench Technology for Extremely Low RDS(ON)
- This Device is Pb–Free, Halide Free and is RoHS Compliant

Symbol	Parameter		Value	Unit	
V _{DS}	Drain to Source Voltage		30	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	–Continuous T _A = 25°C	(Note 1a)	6.3	А	
	-Pulsed		20		
PD	Power Dissipation	(Note 1a)	1.6	W	
		(Note 1b)	0.8		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

MOSFET MAXIMUM RATINGS (T_C = 25°C, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Max	Unit
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	78	°C/W

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	25 mΩ @ 10 V	6.3 A
	33 mΩ @ 4.5 V	



TSOT23 6–Lead (SUPERSOT [™] –6) CASE 419BL

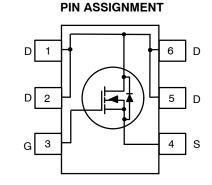
MARKING DIAGRAM



55B = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)



ORDERING INFORMATION

Device	Package	Shipping [†]
FDC655BN	TSOT23–6 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
OFF CHARAG	OFF CHARACTERISTICS							
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V,$	30	-	-	V		
$\Delta {\rm BV}_{\rm DSS}$ / $\Delta {\rm T}_{\rm J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 $\mu A,$ referenced to 25°C	-	25	-	mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V	-	-	1	μΑ		
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±100	nA		

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1	1.9	3	V
${\Delta V_{GS(th)} \over \Delta T_J}/$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25°C	-	-5	-	mV/°C
R _{DS(ON)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 6.3 A	-	21	25	mΩ
		V_{GS} = 4.5 V, I _D = 5.5 A	-	26	33	
		V_{GS} = 10 V, I_{D} = 6.3 A, T_{J} = 125 $^{\circ}C$	-	30	36	
9 FS	Forward Transconductance	V_{DS} = 10 V, I_{D} = 6.3 A	-	35	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	-	470	620	pF
C _{oss}	Output Capacitance		-	100	130	pF
C _{rss}	Reverse Transfer Capacitance		-	60	90	pF
Rg	Gate Resistance		-	3.0	-	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 1 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	6	11	ns
t _r	Rise Time	$R_{GEN} = 6 \Omega$	-	2	10	ns
t _{d(off)}	Turn-Off Delay Time		-	15	26	ns
t _f	Fall Time		-	2	10	ns
Q _{g(Tot)}	Total Gate Charge	V_{GS} = 0 V to 10 V, V_{DD} = 15 V, I_{D} = 6.3 A	-	9	13	nC
Q _{g(Tot)}	Total Gate Charge	V_{GS} = 0 V to 5 V, V_{DD} = 15 V, I_{D} = 6.3 A	-	5	7	nC
Q _{gs}	Gate to Source Charge	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$	-	1.4	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	1.6	-	nC

DRAIN-SOURCE DIODE CHARACTERISTICS

I _S	Maximum Continuous Drain-Source Diode Forward Current		_	_	1.3	А
V _{SD}	Source-Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.3 A (Note 2)	-	0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 6.3 A, di/dt = 100 A/μs	-	15	26	ns
Q _{rr}	Reverse Recovery Charge		-	4	10	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design. a. 78°C/W when mounted on a 1 in² pad of 2 oz copper on FR-4 board.

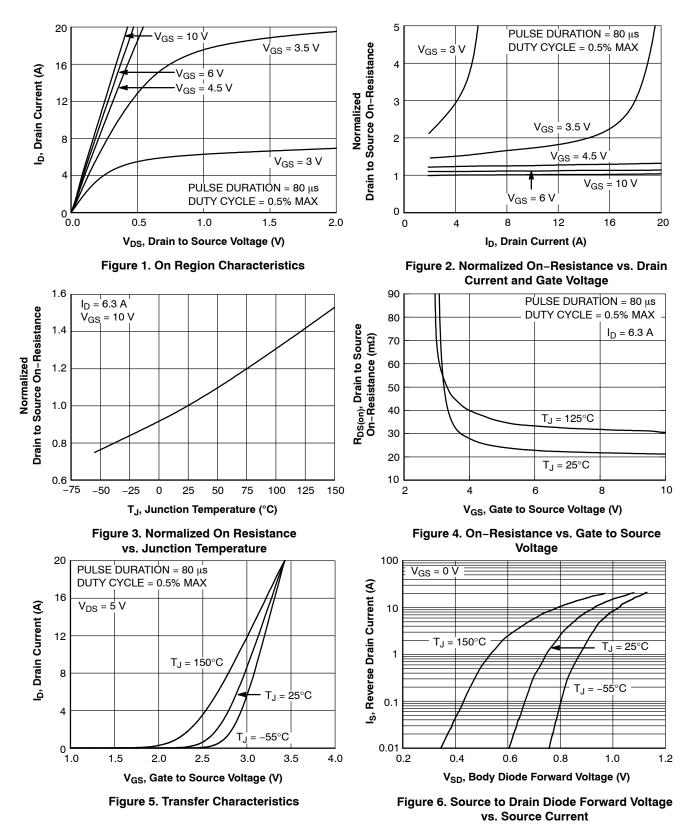
b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

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TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)



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TYPICAL CHARACTERISTICS (continued)

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

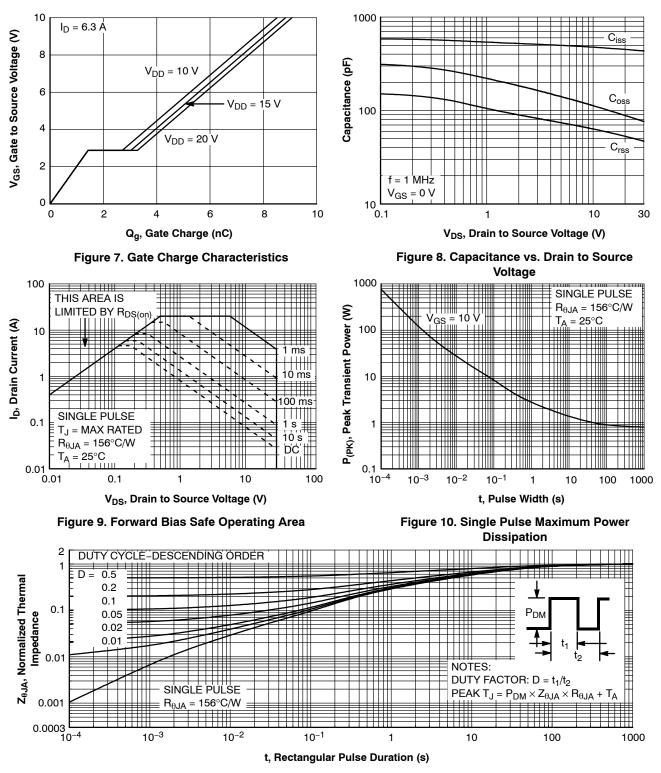
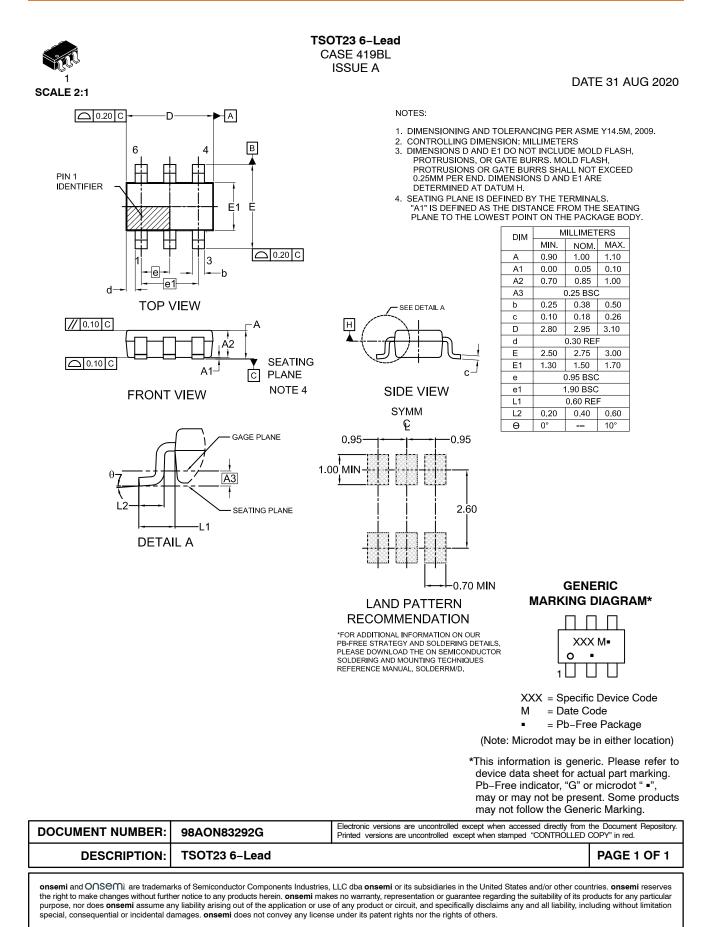


Figure 11. Junction-to-Ambient Transient Thermal Response Curve

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